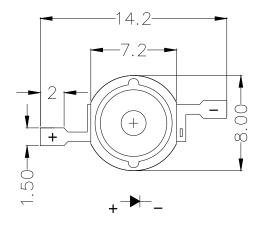
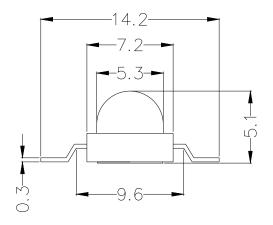
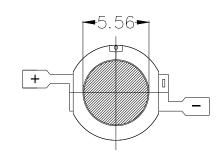
# **Approval Sheet**

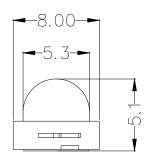
Customer:
Item: High Power LED – 1 W
Part No.: WLB28-140-XX1
Customer P/N:
Customer Approval

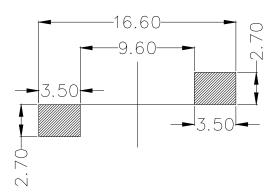
# **PACKAGE DIMENSIONS**











#### Note:

- 1. All Dimensions are in millimeters
- 2. Tolerance is  $\pm 0.25$ mm (0.010") Unless otherwise specified.

# **Device Selection Guide**

Material	Emitting Color	Lens Type
	Blue	Water Clear

# **Absolute Maximum Ratings at Ta=25** ℃

Parameter	Symbol	Max	Unit
Power Dissipation	P <sub>D</sub>	1.2	W
Peak Forward Current 1/10 Duty Cycle,0.1ms Pulse Width	I <sub>FP</sub>	500	mA
Continuous Forward Current	I <sub>F</sub>	350	mA
Reverse Voltage	V <sub>R</sub>	5	V
ESD Sensitivity	ESD	2000	V
Operating Temperature Range	Topr	-40℃ to+80℃	
Storage Temperature Range	Tstg	-25℃ to+100℃	

# **Electrical Optical Characteristics at Ta=25** ℃

Parameter	Symbol	Min	Тур	Max	Unit	Conditio
Forward Voltage	VF	3.0	3.4		V	IF=350mA
luminous flux	IV	15	25		lm	IF=350mA
Dominant Wavelength	λd	450	460		nm	IF=350mA
Temperature Color	ССТ				K	IF=350mA
Reverse Current	IR			10	μA	IF=350mA
Viewing Angle	201/2		120		deg	IF=350mA

#### Note.

- 1. 201/2 is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
  - 2. View angle tolerance is  $\pm$  10

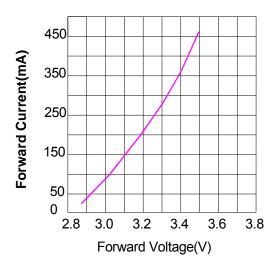
REV: A/0 APPOVED:

PAGE: 3/7 CHECKED:

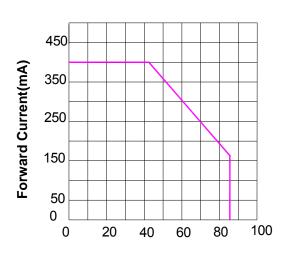
DATE: 2010-7-12 DRAWN:

# **Typical Electro-Optical Characteristics Curves**

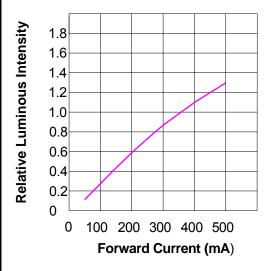
# Relative Luminous Intensity vs Forward Current, *T* Ambient=250 C



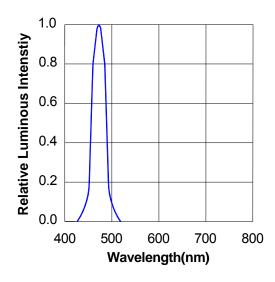
# Forward Current Derating Curve, Derating based on Tjmax=125° C



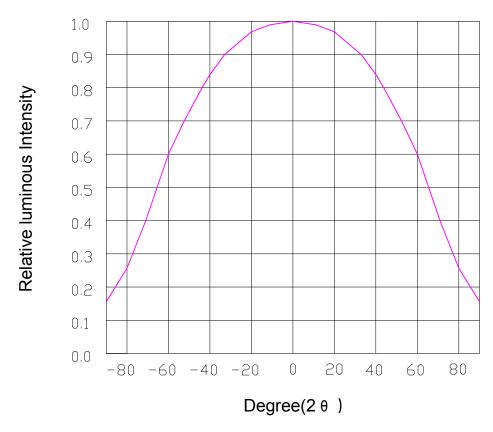
# Relative Luminous Intensity vs Forward Current, *T Ambient*=25o C



# Relative Spectral Distribution, IF=350mA, T Ambient=25o C



# **Typical Representative Spatial Radiation Pattern**



#### Note.

- 1.  $2\theta 1/2$  is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is ± 10

#### **Luminous Flux Bin Table** (Im at 350mA)

BIN	Lb	Lb	Lb	Lb
Luminous Flux	10-15	15-20	20-30	30-40

<sup>\*</sup>Measure Uncertainty of Luminous Flux:±10%

# Forward Voltage Combination(V at 350mA)

BIN	S	Т	U	V
Forward Voltage	3.0-3.2	3.2-3.4	3.4-3.6	3.6-3.8

<sup>\*</sup>Measure Uncertainty of Forward Voltage:±0.1V

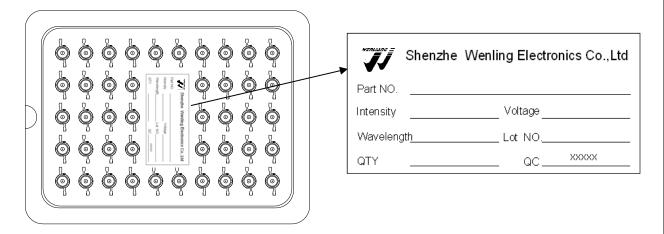
REV: A/0 APPOVED:

PAGE: 5/7 CHECKED:

DATE: 2010-7-12 DRAWN:

#### **Packing Specification**

◆Anti-electrostatic bag



## 1. Storage

- 1. Do not open the moisture proof bag before the devices are ready to use.
- 2. Before the package is opened, LEDs should be stored at temperatures less than  $30^{\circ}$ C and humidity less than  $90^{\circ}$ .
  - 3. LEDs should be used within a year.
- 4. After the package is opened, LEDs should be stored at temperatures less than  $30^{\circ}$ C and humidity less than  $60^{\circ}$ M.
  - 5. LEDs should be used within 168 hours (7 days) after the package is opened.
- 6. If the moisture absorbent material (silicone gel) has faded away or LEDs have exceeded the storage time, baking treatment should be implemented based on the following conditions: pre-curing at  $60\pm5$ °C for 24 hours.

### 2. Thermal Management

- 1). For maintaining the high flux output and achieving reliability, LEDs should be mounted on a metal core printed circuit board (MCPCB) or other kinds of heat sink with proper thermal connection to dissipate approximately 1W of thermal
  - 2). Don't reflow soldwer.
- 3). Sufficient thermal management must be implemented. Otherwise, the junction temperature of die may exceed over the limit at high current driving conditions and the LEDs' lifetime may be decrease dramatically.
- 4). For further thermal management suggestions, please consult the Wenliang Design Guide or local representatives for assistance.
- 5). Special thermal designs are also recommended to take in outer heat sink design, such as FR4 PCB on Aluminum with thermal vias or FPC on Aluminum with thermal conductive adhesive, etc.

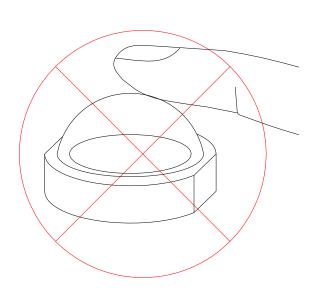
REV: A/0 APPOVED:

PAGE: 6/7 CHECKED:

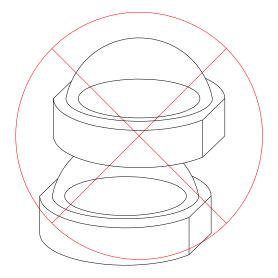
DATE: 2010-7-12 DRAWN:

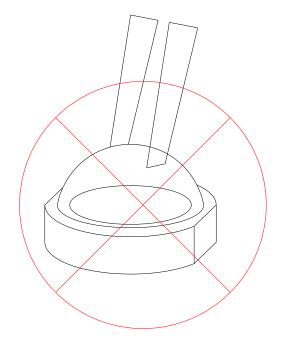
# 3.Proper Handling

Please do not touch leds as four pictures listed below.

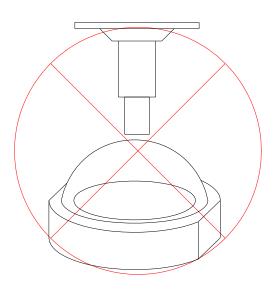


Do not press on the resin directly.





Do not touch the resin.



Do not stack the led together. Avoid directly contacting with nozzle.